

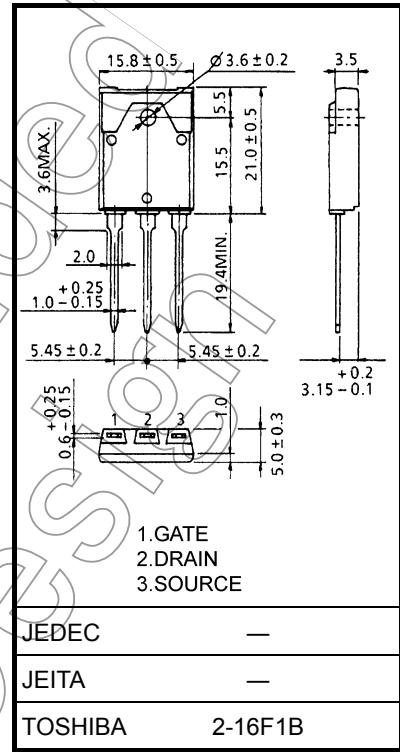
TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSII⁵)

2SK1365

Switching Power Supply Applications

Unit: mm

- Low drain-source ON resistance : $R_{DS(ON)} = 1.5 \Omega$ (typ.)
- High forward transfer admittance : $|Y_{fs}| = 4.0 \text{ S}$ (typ.)
- Low leakage current : $I_{DSS} = 300 \mu\text{A}$ (max) ($V_{DS} = 800 \text{ V}$)
- Enhancement mode : $V_{th} = 1.5$ to 3.5 V ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	1000	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	1000	V
Gate-source voltage	V_{GSS}	± 20	V
Drain current	DC (Note 1)	I_D	A
	Pulse (Note 1)	I_{DP}	
Drain power dissipation ($T_c = 25^\circ\text{C}$)	P_D	90	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to 150	$^\circ\text{C}$

Weight: 5.8 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th}(ch-c)$	1.39	$^\circ\text{C} / \text{W}$
Thermal resistance, channel to ambient	$R_{th}(ch-a)$	41.6	$^\circ\text{C} / \text{W}$

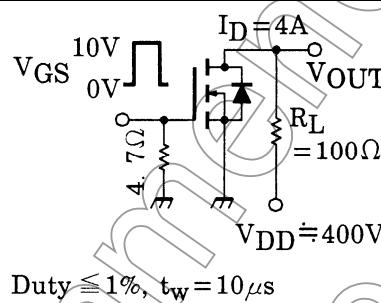
Note 1: Ensure that the channel temperature does not exceed 150°C.

This transistor is an electrostatic-sensitive device.

Please handle with caution.

Electrical Characteristics (Ta = 25°C)

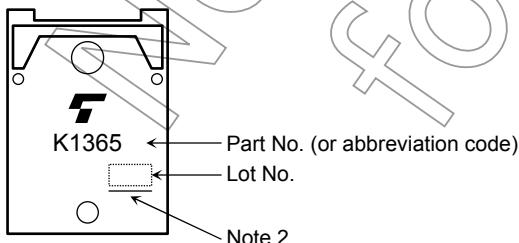
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V	—	—	±50	nA
Drain cut-off current	I _{DSS}	V _{DS} = 800 V, V _{GS} = 0 V	—	—	300	µA
Drain-source breakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	1000	—	—	V
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5	—	3.5	V
Drain-source ON resistance	R _{DSS} (ON)	I _D = 4 A, V _{GS} = 10 V	—	1.5	1.8	Ω
Forward transfer admittance	Y _{fs}	V _{DS} = 20 V, I _D = 4 A	2.0	4.0	—	S
Input capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	1300	—	—	pF
Reverse transfer capacitance	C _{rss}		—	100	—	
Output capacitance	C _{oss}		—	180	—	
Switching time	Rise time	t _r	—	25	—	ns
	Turn-on time	t _{on}	—	40	—	
	Fall time	t _f	—	20	—	
	Turn-off time	t _{off}	—	100	—	
Total gate charge (Gate-source plus gate-drain)	Q _g	V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 7 A	—	120	—	nC
Gate-source charge	Q _{gs}		—	70	—	
Gate-drain ("miller") charge	Q _{gd}		—	50	—	



Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	—	—	7	A
Pulse drain reverse current (Note 1)	I _{DRP}	—	—	—	21	A
Forward voltage (diode)	V _{DSF}	I _{DR} = 7 A, V _{GS} = 0 V	—	—	-1.9	V

Marking

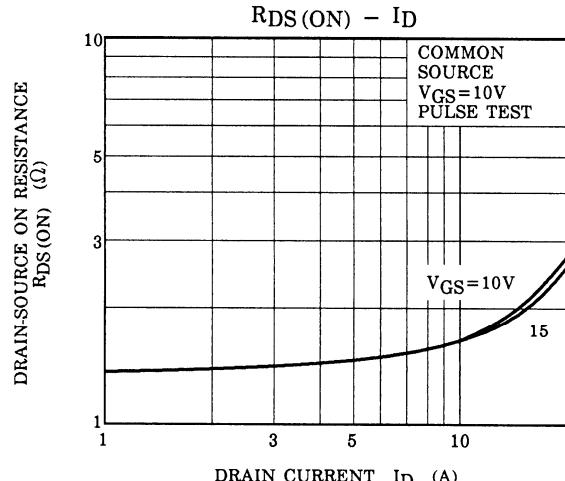
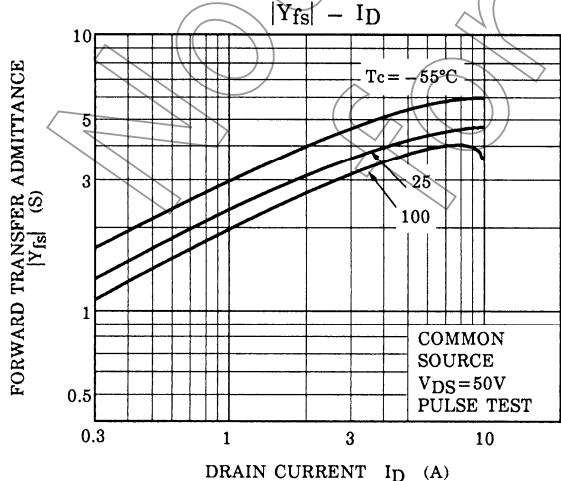
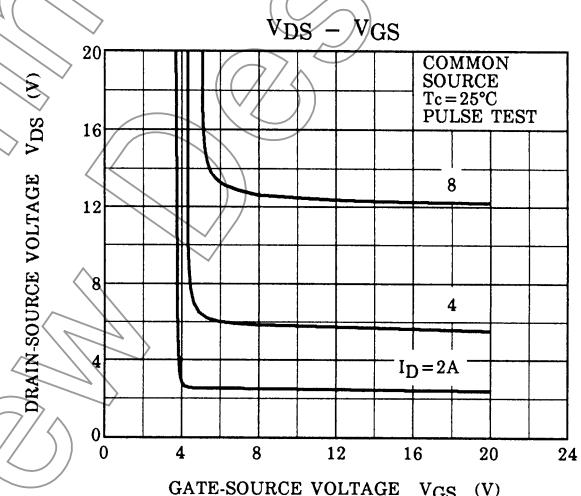
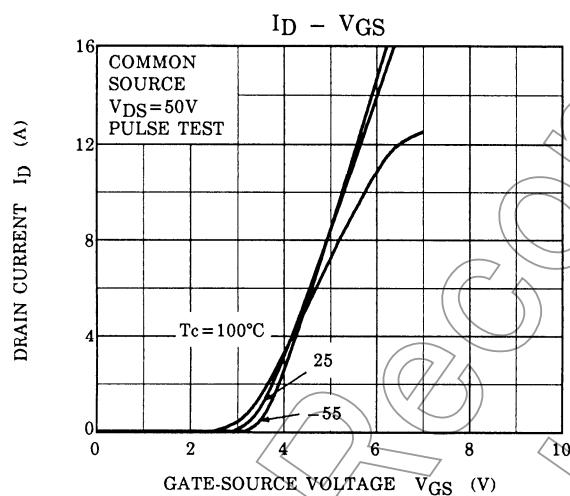
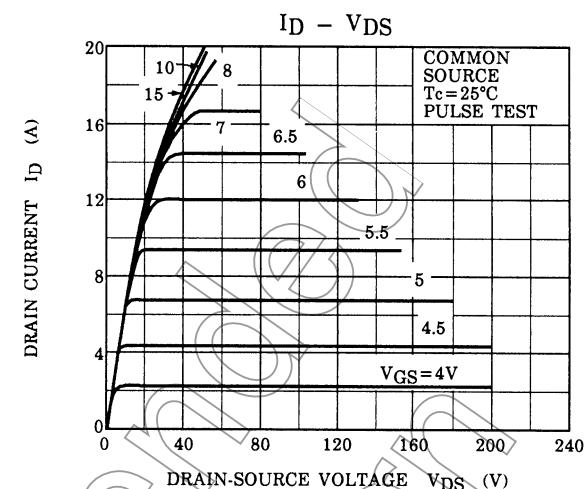
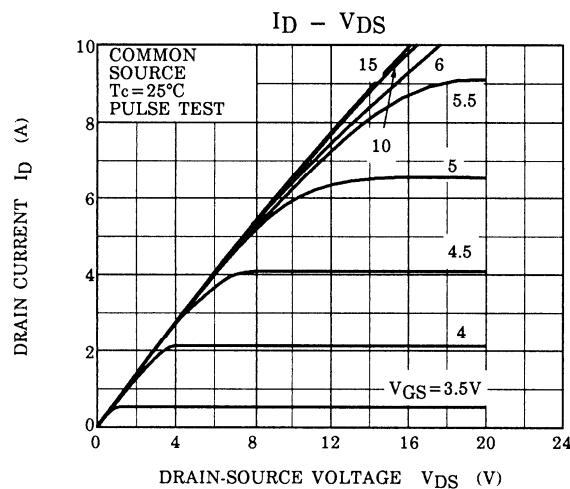


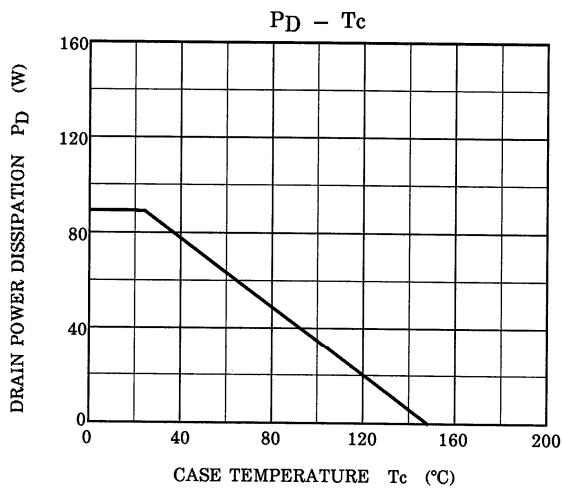
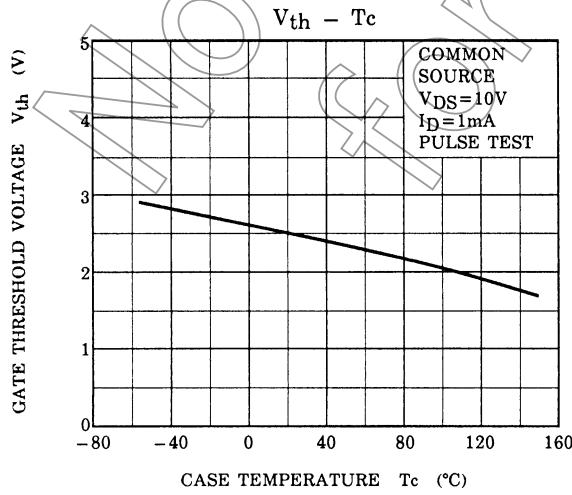
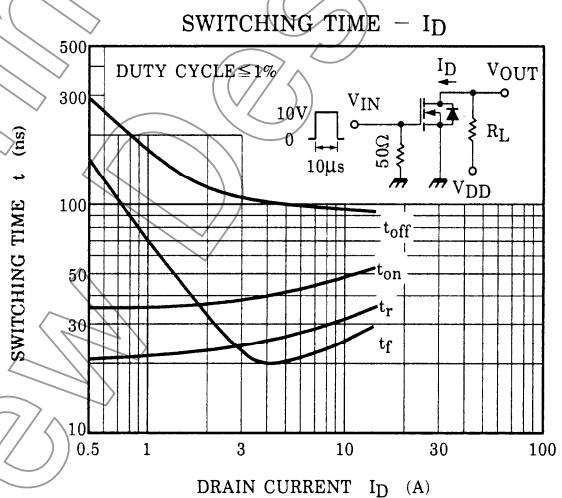
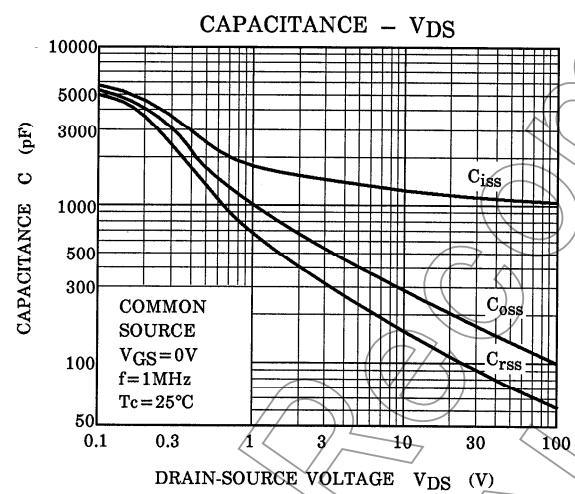
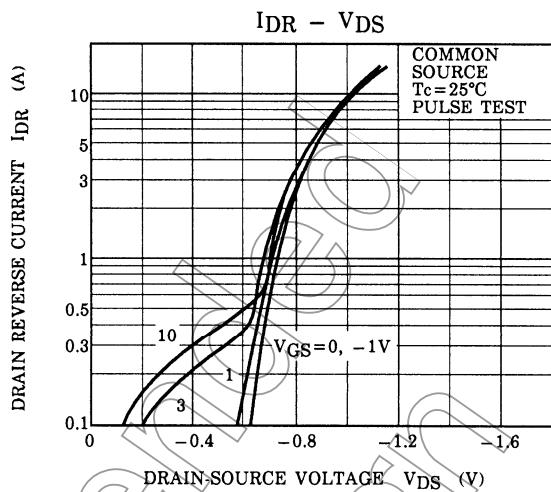
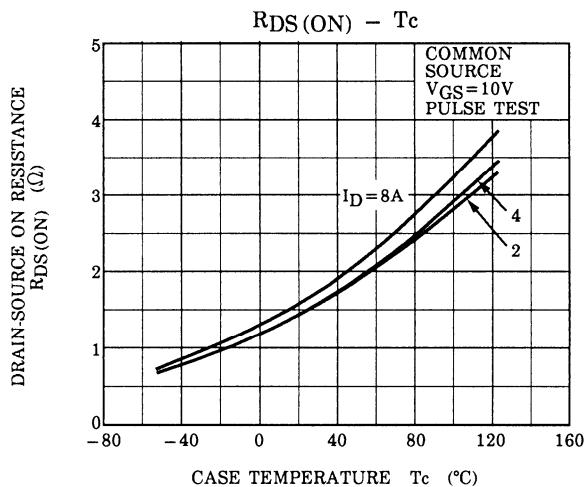
Note 2: A line under a Lot No. identifies the indication of product Labels.

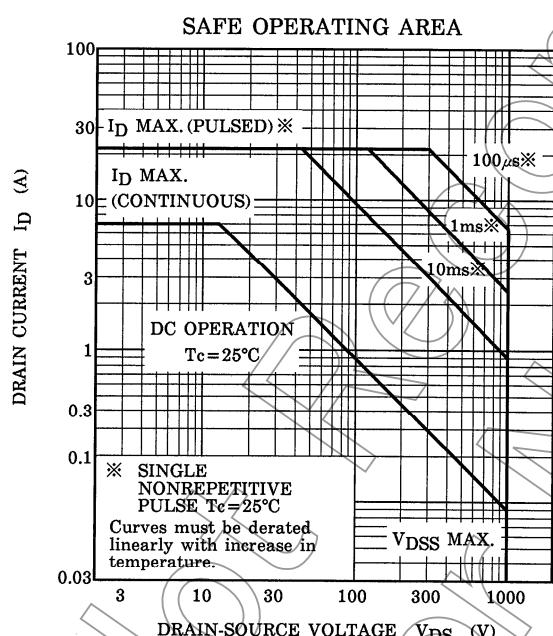
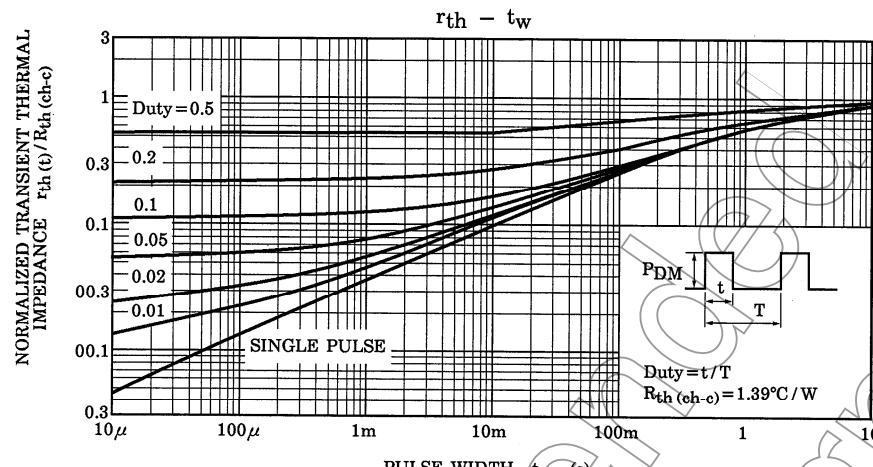
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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